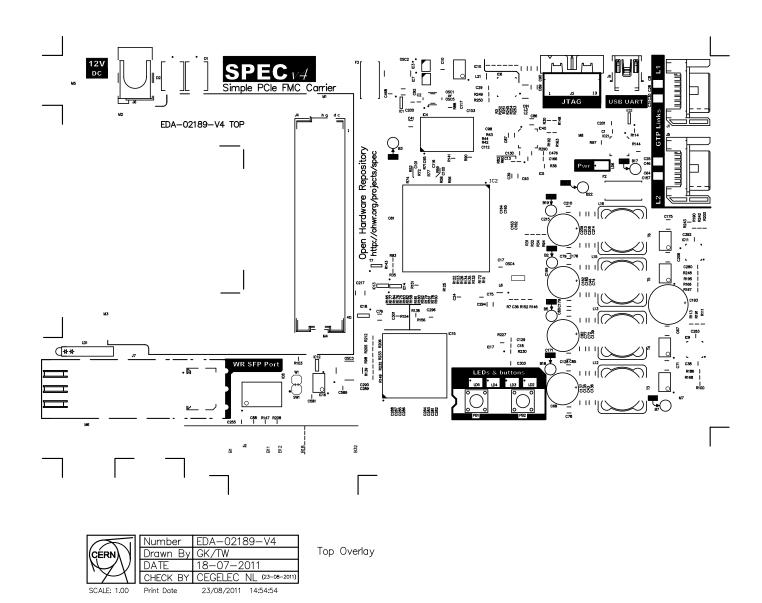
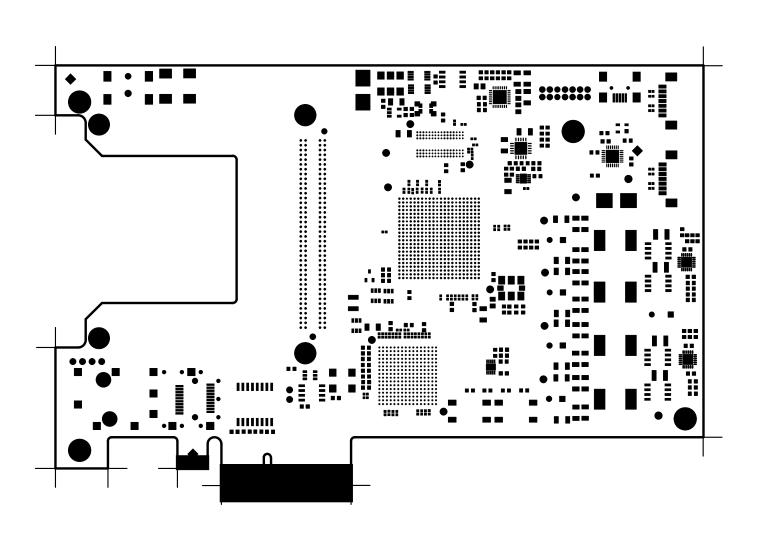


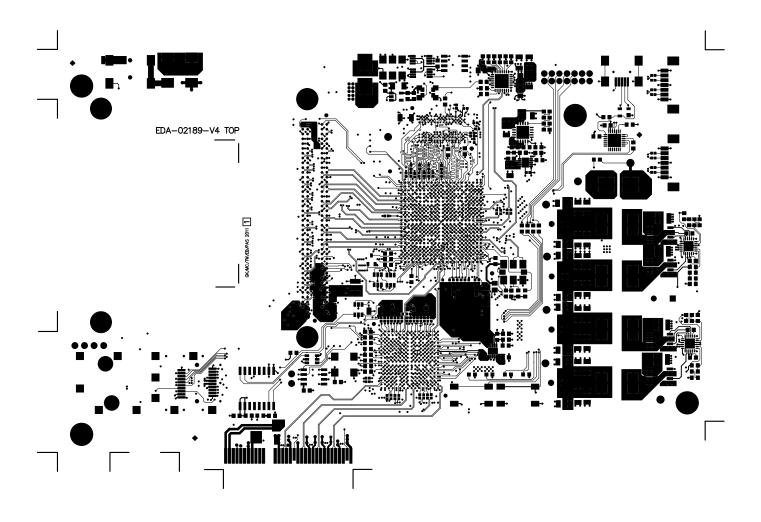
	Number	EDA-02189-V4	
CÉRN	Drawn By	GK/TW	
	DATE	18-07-2011	
	CHECK BY	CEGELEC NL (23-08-2011)	
SCALE: 1.00	Print Date	23/08/2011 14:55:01	





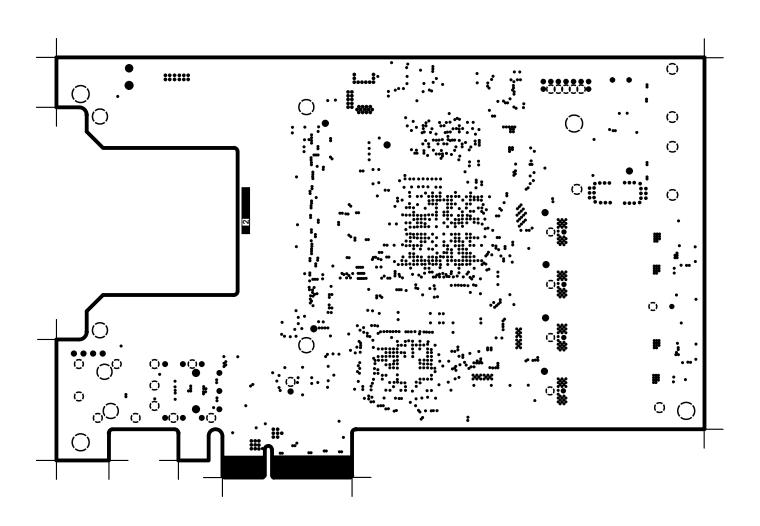
	Number	EDA-02189-V4	
(CÉRN)	Drawn By	GK/TW	
	DATE	18-07-2011	
	CHECK BY	CEGELEC NL (23-08-2011)	
SCALE: 1.00	Print Date	23/08/2011 14:54:59	

Top Solder

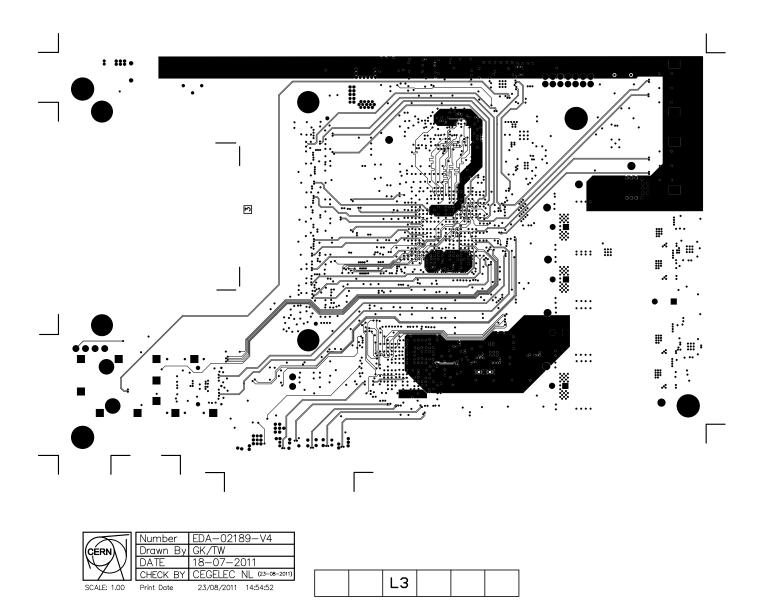


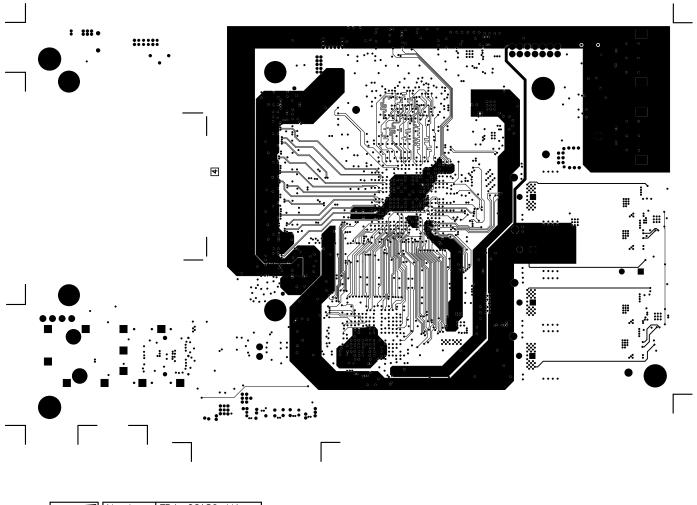
| Number | EDA-02189-V4 | Drawn By GK/TW | DATE | 18-07-2011 | CHECK BY | CEGELEC | NL (23-08-2011) | CHECK BY | CEGELEC | NL (23-08-2011) | L1 |

1 1 1	l		
1 L1	l		
	l		

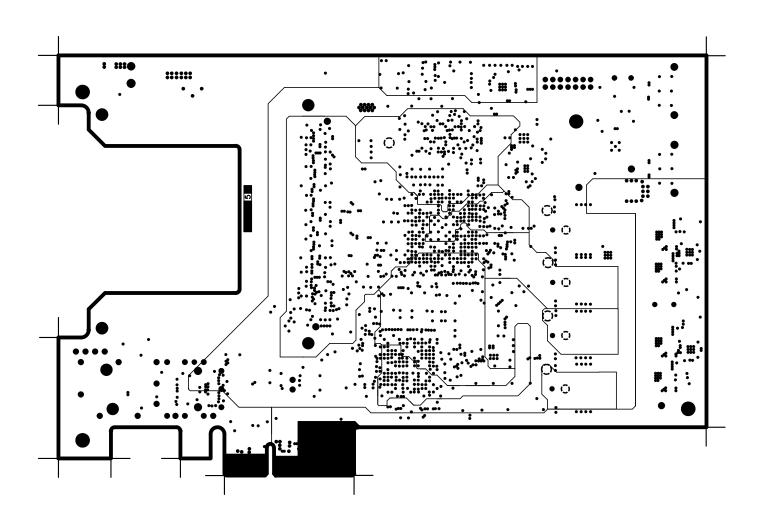


	Number	EDA-02189-V4
CÉRN	Drawn By	GK/TW
	DATE	18-07-2011
	CHECK BY	CEGELEC NL (23-08-2011)
SCALE: 1.00	Print Date	23/08/2011 14:54:59

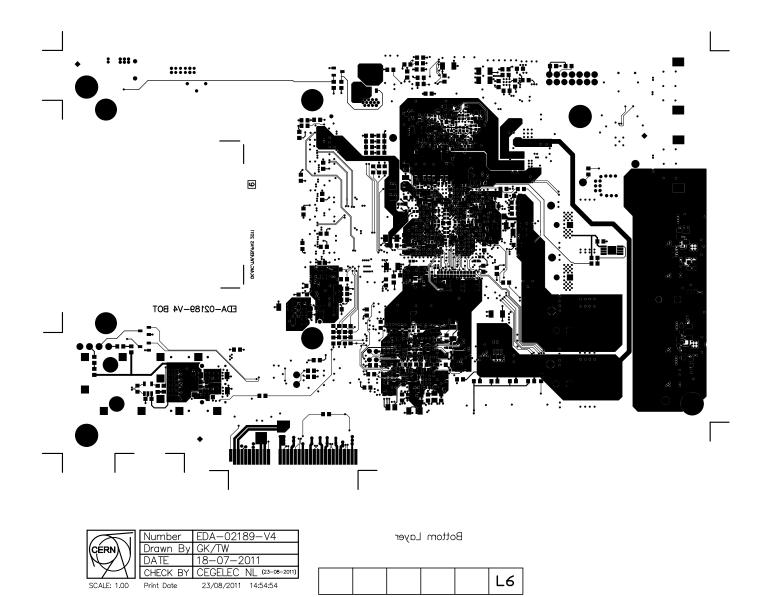


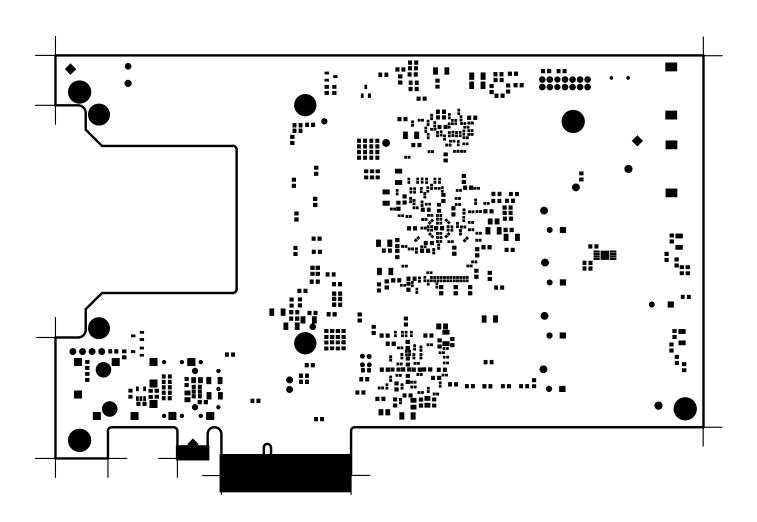


	Number	EDA-02189-V4
CÉRN	Drawn By	GK/TW
	DATE	18-07-2011
	CHECK BY	CEGELEC NL (23-08-2011)
SCALE: 1.00	Print Date	23/08/2011 14:54:52



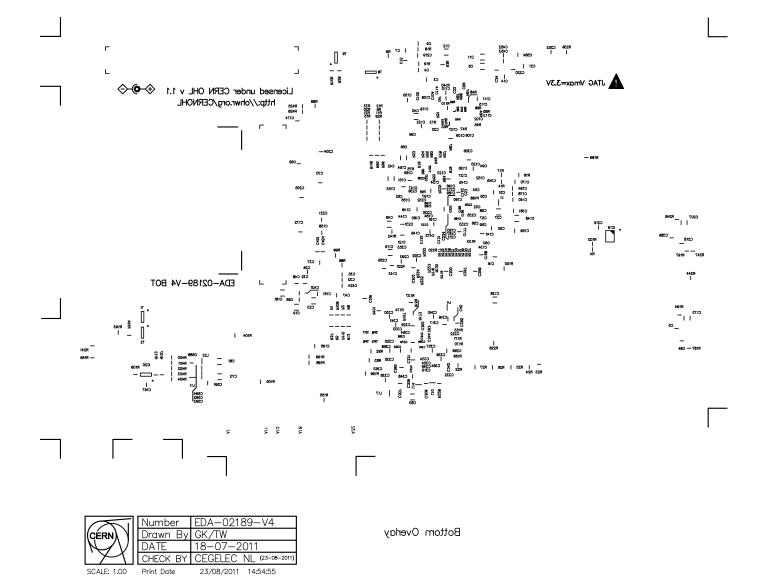
CERN	Number	EDA-02189-V4
	Drawn By	GK/TW
	DATE	18-07-2011
	CHECK BY	CEGELEC NL (23-08-2011)
SCALE: 1.00	Print Date	23/08/2011 14:54:59

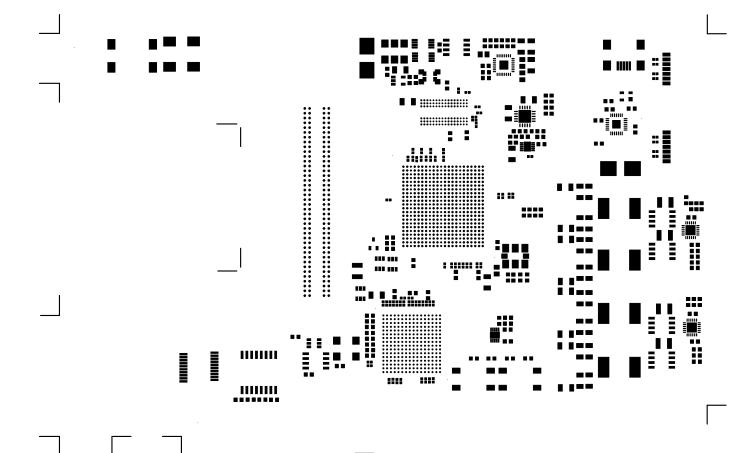




		EDA-02189-V4		
(CÉRN)	Drawn By	GK/TW		
$ V \vee V $	DATE	18-07-2011		
	CHECK BY	CEGELEC NL (23-08-2011)		
SCALE: 1.00	Print Date	23/08/2011 14:54:59		

Bottom Solder



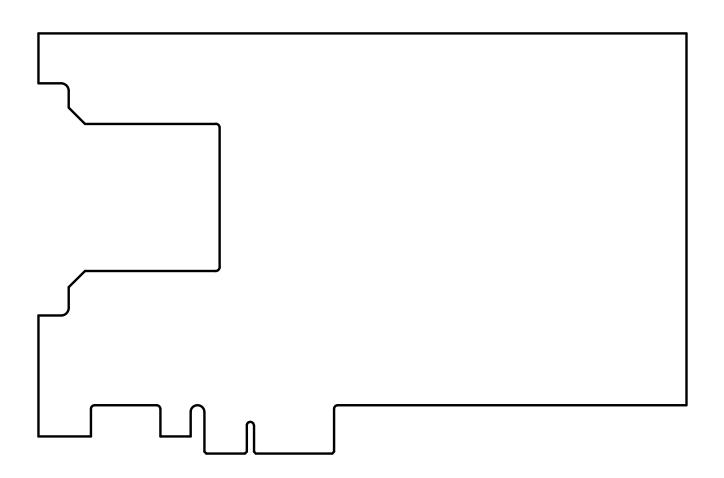


Top Paste



| Number | EDA-02189-V4 |
| Drawn By GK/TW |
| DATE | 18-07-2011 |
| CHECK BY | CEGELEC | NL (23-08-2011) |
| SCALE: 1.00 | Print Date | 23/08/2011 | 14:54:55

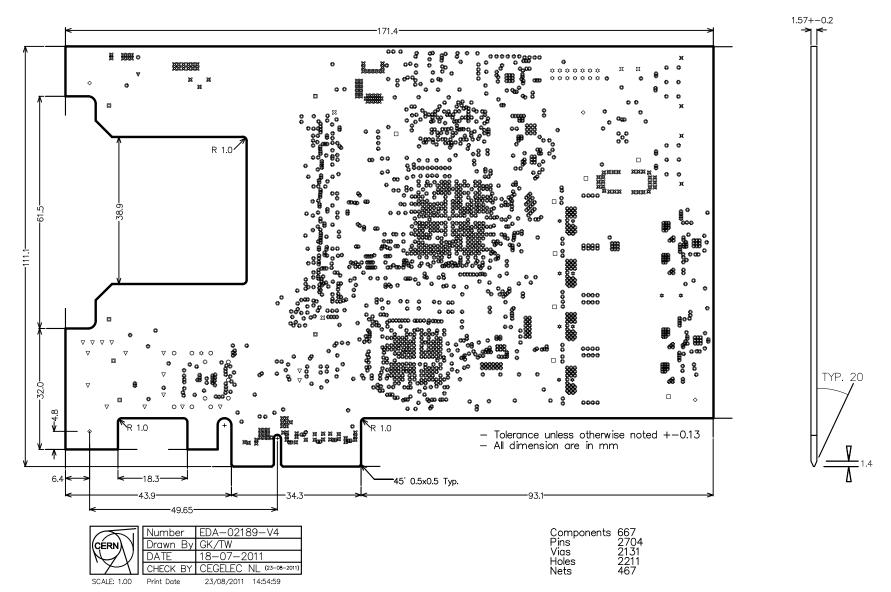
Bottom Paste



Symbol	Hit Count	Tool Size	Plated	Hole Type
Ф	2006	7.874mil (0.2mm)	PTH	Round
×	125	13.78mil (0.35mm)	PTH	Round
*	10	31.496mil (0.8mm)	PTH	Round
¤	2	35.433mil (0.9mm)	NPTH	Round
❖	15	35.433mil (0.9mm)	PTH	Round
0	9	37.402mil (0.95mm)	NPTH	Round
▽	16	41.339mil (1.05mm)	PTH	Round
	8	51.181mil (1.3mm)	PTH	Round
×	2	51.181mil (1.3mm)	NPTH	Round
×	4	59.055mil (1.5mm)	PTH	Round
٥	2	61.024mil (1.55mm)	NPTH	Round
0	1	62.992mil (1.6mm)	NPTH	Round
₹	1	70.866mil (1.8mm)	NPTH	Round
	6	106.299mil (2.7mm)	PTH	Round
♦	4	125.984mil (3.2mm)	PTH	Round
	2211 Total			

LAYER IDENTIFICATION		LINE WIDTH/GAP (Mils)	FINISHED COPPER THICKNESS	CONTROLLED IMPEDANCE +/-10%	DIELECTRIC THICKNESS *=CRITICAL
TOP LAYER	SIGNAL LAYER	5 / 5	35 um	50/*100 Ohms	* 0.1mm
LAYER 2	GND PLANE	_	35 um		
LAYER 3	SIGNAL LAYER	5 / 5	35 um	50/*100 Ohms	* 0.1mm
LAYER 4	SIGNAL LAYER	5/5	35 um	50/*100 Ohms	1.0mm
LAYER 5	POWER PLANE	_	35 um		* 0.1mm
BOTTOM LAYER	SIGNAL LAYER	5/5	35 um	50/*100 Ohms	* 0.1mm
	BOARD THICKNESS	5 +/-10%		1 , 5 - 6 - 6 - 6 - 6 - 6 - 6 - 6 - 6 - 6	1.58 mm

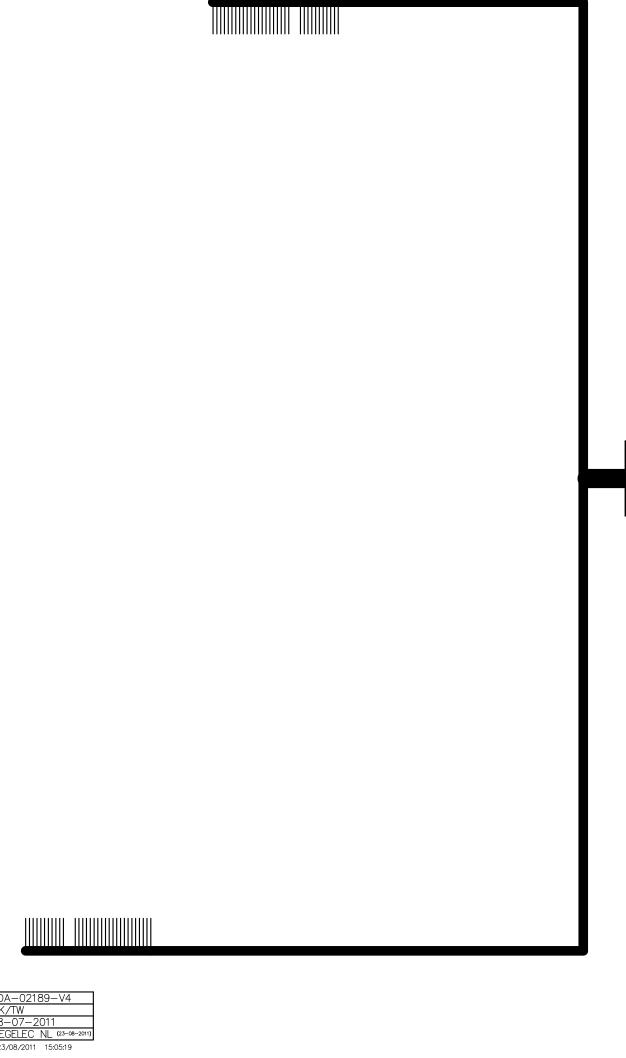
*100 Ohms = Differential Impedance



Copyright CERN 2011

This documentation describes Open Hardware and is licensed under the CERN OHL v 1.0. You may redistribute and modify this documentation under the terms of the CERN OHL v 1.0 (http://ohwr.org/CERNOHL). This documentation is distributed WITHOUT ANY EXPRESS OR MPULED WARRANTY, INCLUDING OF MERCHANTABILITY, SATISFACTORY QUALITY AND FITNESS FOR A PARTICULAR PURPOSE.

Please see the CERN OHL v. 1.0 for applicable conditions.



	Number	ED/
(CÉRN)	Drawn By	GK,
$ V \setminus V $	DATE	18-
	CHECK BY	CEC
SCALE: 1.00	Print Date	23,